



N-Channel Power MOSFET

60V, 300mA, 2Ω

FEATURES

- Low On-Resistance
- ESD Protected 2KV
- **High Speed Switching**
- Low Voltage Drive

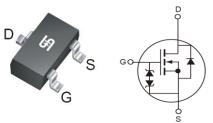
| KEY PERFORMANCE PARAMETERS | | | | |
|-----------------------------------|-----------------|-------|------|--|
| PARAMETER | | VALUE | UNIT | |
| V _{DS} | | 60 | V | |
| R _{DS(on)} (max) | $V_{GS} = 10V$ | 2 | | |
| | $V_{GS} = 4.5V$ | 4 | Ω | |
| Qg | | 0.4 | nC | |

APPLICATION

- Logic Level translators
- **DC-DC Converter**







Note: MSL 3 (Moisture Sensitivity Level) per J-STD-020

| ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted) | | | | | |
|---|------------------------|-----------------------------------|--------------|------|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | V _{DS} | 60 | V | |
| Gate-Source Voltage | | V _{GS} | ±20 | V | |
| Continuous Drain Current (Note 1) | $T_A = 25^{\circ}C$ | - I _D | 300 | | |
| | T _A = 100°C | | 180 | mA | |
| Pulsed Drain Current (Note 2) | | I _{DM} | 800 | mA | |
| Total Power Dissipation @ $T_A = 25^{\circ}C$ | | P _{DTOT} | 300 | mW | |
| Single Pulsed Avalanche Energy (Note 3) | | E _{AS} | 0.2 | mJ | |
| Single Pulsed Avalanche Current (Note 3) | | I _{AS} | 2 | А | |
| Operating Junction and Storage Tempera | ature Range | T _J , T _{STG} | - 55 to +150 | °C | |

| THERMAL PERFORMANCE | | | | | |
|--|------------------|-------|------|--|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | | |
| Junction to Ambient Thermal Resistance | R _{eja} | 350 | °C/W | | |

Notes: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistances. The case thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JC}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. $R_{\Theta JA}$ shown below for single device operation on FR-4 PCB in still air

TSM2N7002KCX Taiwan Semiconductor



| PARAMETER | CONDITIONS | SYMBOL | MIN | ТҮР | MAX | UNIT |
|----------------------------------|---|------------------------|-----|-----|-----|------|
| Static (Note 4) | | | | • | • | |
| Drain-Source Breakdown Voltage | $V_{GS} = 0V, I_D = 10\mu A$ | BV _{DSS} | 60 | | | V |
| Gate Threshold Voltage | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | V _{GS(TH)} | 1.0 | 1.5 | 2.5 | V |
| Gate Body Leakage | $V_{GS} = \pm 20V, V_{DS} = 0V$ | I _{GSS} | | | ±10 | μA |
| Zero Gate Voltage Drain Current | V _{DS} =60V, V _{GS} =0V | I _{DSS} | | | 1.0 | μA |
| | $V_{GS} = 10V, I_{D} = 300mA$ | | | 1.2 | 2 | - Ω |
| Drain-Source On-State Resistance | V _{GS} =4.5V, I _D =200mA | R _{DS(ON)} | | 2 | 4 | |
| Forward Transconductance | V _{DS} =10V, I _D =200mA | g _{fs} | 100 | | | mS |
| Diode Forward Voltage | I _S =300mA, V _{GS} =0V | V _{SD} | | 0.8 | 1.4 | V |
| Dynamic (Note 5) | | | | | | • |
| Total Gate Charge | $V_{DS} = 10V, I_D = 250mA,$ $V_{GS} = 4.5V$ | Qg | | 0.4 | 0.6 | nC |
| Input Capacitance | $V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz | C _{iss} | | 30 | | |
| Output Capacitance | | C _{oss} | | 6 | | pF |
| Reverse Transfer Capacitance | | C _{rss} | | 2.5 | | |
| Gate Resistance | F = 1MHz, open drain | R _g | | 70 | | Ω |
| Switching (Note 6) | · | | | | | |
| Turn-On Delay Time | $V_{DD} = 30V, R_{G} = 10\Omega$ | t _{d(on)} | | 25 | | |
| Turn-Off Delay Time | I_D =200mA, V_{GEN} =10V, $t_{d(off)}$ | t _{d(off)} | | 35 | | ns |
| Source-Drain Diode (Note 4) | | | | | | |
| Diode Forward Voltage | I _S =300mA, V _{GS} =0V | V _{SD} | | 0.8 | 1.4 | V |
| Reverse Recovery Time | I _S = 0.5A | t _{rr} | | 40 | | ns |
| Reverse Recovery Charge | dI _F /dt = 100A/µs | Q _{rr} | | 39 | | nC |

Notes:

- 1. Current limited by package
- 2. Pulse width limited by the maximum junction temperature
- 3. L = 0.1mH, I_{AS} = 2A, V_{DD} = 25V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C
- Pulse test: PW \leq 300µs, duty cycle \leq 2% 4.
- For DESIGN AID ONLY, not subject to production testing. 5.
- Switching time is essentially independent of operating temperature. 6.



ORDERING INFORMATION

| ORDERING CODE | PACKAGE | PACKING |
|------------------|---------|--------------------|
| TSM2N7002KCX RFG | SOT-23 | 3,000pcs / 7" Reel |

Note:

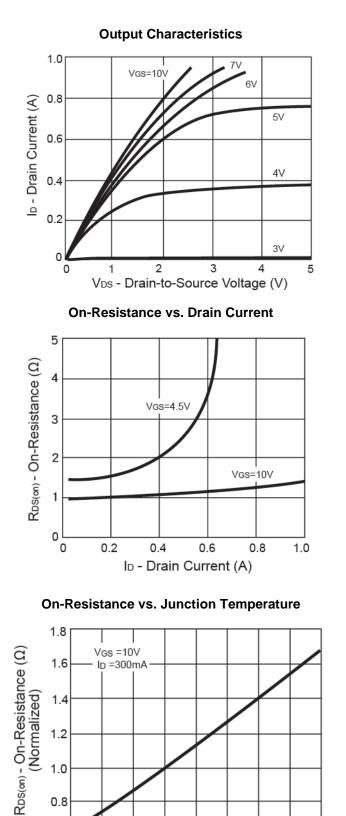
1. Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC

2. Halogen-free according to IEC 61249-2-21 definition

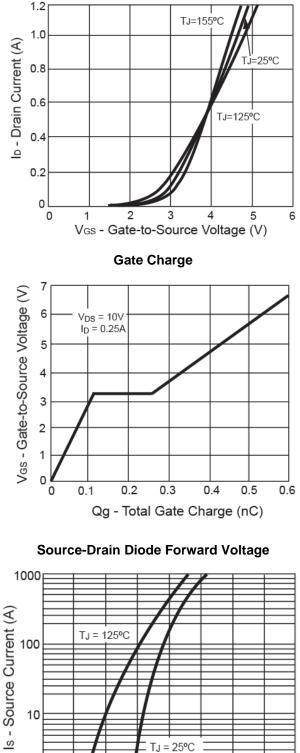


CHARACTERISTICS CURVES

(T_C = 25°C unless otherwise noted)



Transfer Characteristics



25

0

50

Tj - Junction Temperature (°C)

75

100 125 150

1.0

0.8

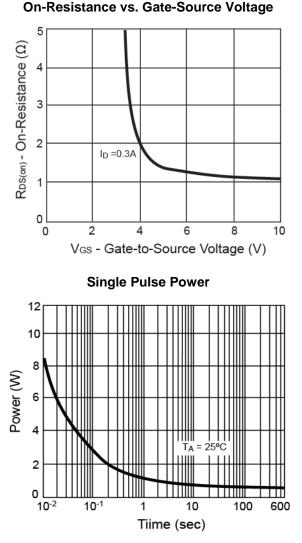
0.6

-50 -25



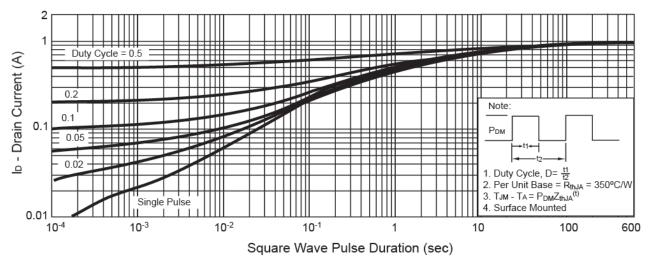
CHARACTERISTICS CURVES

 $(T_C = 25^{\circ}C \text{ unless otherwise noted})$



Threshold Voltage 0.4 0.2 V_{GS(th)} - Variance (V) ID = 250uA -0.0 -0.2 -0.4 -0.6 -0.8 -50 -25 0 25 50 75 100 125 150 Tj - Junction Temperature (°C)

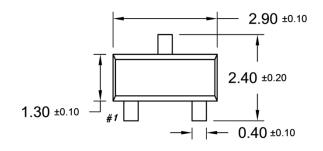
Normalized Thermal Transient Impedance, Junction-to-Ambient

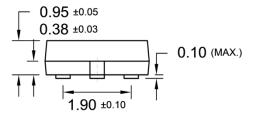


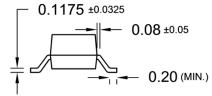


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

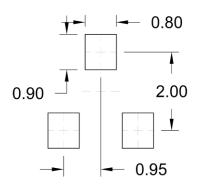
SOT-23



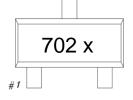




SUGGESTED PAD LAYOUT (Unit: Millimeters)



MARKING DIAGRAM



702 = TSM2N7002KCX Device Code

X = Internal Code



TSM2N7002KCX

Taiwan Semiconductor

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